

Automated Design Rule Check for EMC Design

High Level Overview of DRC tools

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Outline

- What are Design Checking Rules (DRC) tools ?
 - Are they useful?
- Evaluation of DRC tools
 - Evaluation Criteria
- DRC Workflow Example and Possible Automation
- Design Guidelines / EMC Rules Parameter Optimization
 - Some Examples
- Conclusions and Recommendations

DRC Tools Overview

DRC review

- Time consuming model set-up
- False violations
- Identifying critical nets
- Specifying naming conventions for the tool to recognize the type of signal "gnd", "***_N and ***_P"
- Automation of the DRC

Manual board review

- Process is time consuming and prone to errors. This is particularly true in PCB with many layers and hundreds of nets
- No need to formally identify critical nets
- Naming conventions are in general self explanatory: gnd, clk, P5V, etc..
- Has to be repeated at each board review

DRC tools is useful to check PCB revisions according to predefined design guidelines and parameters.

Evaluation of DRC tools

Tool Evaluation Criteria

- Number and type of rules supported
- Setup time
 - Selecting rules & nets
- Tool effectiveness
- Possible automation
 - Not using GUI
- Learning curve
 - User friendliness / GUI
- Support, training
 - Accessibility to training
 - Response time of support
- Loading time
- Format of board file supported (.brd, odb++, ...)
- 2D/3D Viewer
- Price

Google

Tool Effectiveness

- False or missing violations
- Feasibility to add new rules
 - Time required and Complexity
 - Rule Customization
- Violation visualization and explanations
- Integration with PCB Layout tools
- Saving rule checking settings for the revised board
- Run time

4

The Typical Rule Checking Workflow

Select and tag nets (can be time consuming)

• Signal specification, net class, differential net, clock net

Select and tag components

• IC, clock driver, oscillator, capacitor type, passive type, connector

Manage rule set and parameters (may require simulations, EMC experience)

• Signal Reference, Wiring/Crosstalk, Decoupling, Placement, Net & Via Integrity

Start and view violations, discard false violations

• Press the Start button and wait for the EMC & SI/PI violations to be listed

Example of Managing rules and parameters

Net Crossing Split In Reference Plane		
Description		
Selected nets must not cross a split in the adjacent reference plane in order 1. Any crossing of an adjacent plane by a selected net will cause a violation 2. A crossing is allowed only if two stitching capacitors (one on either side o	r to prevent large current retu , f the crossing point) are withi	urn loops. n a specified distan
Maximum Allowable Distance from Net Crossing to Stitching Caps	7.62	[mm]
Maximum Allowable Return Current Diversion	10.16	[mm]
Only Identify Gaps Between Planes on the Same Layer		
Recognize Dual Plane Reference Within	0.101	[mm]
Maximum Distance Between Crossing Points for Combination as Single Gap	0.12	[mm]
Suppress Violations for Traces Connected to Via in Gap		
Maximum Distance from Reference Plane for Via in Gap	1.25	[mm]
Net Choice	Selected Nets Only, 👻	

Rule Definition Example in a DRC tool

What the Maximum Allowable Distance from Net Crossing to Stitching Caps should be? Why 7.62 mm?

Is a stitching cap going to work at high frequency?

What is the ESL of the stitching cap?

Example of false violations: reset lines, USB lines crossing gaps if USB will not be used in typical operating conditions (diagnostic and recovery mode)

DRC Automation Opportunities

- NET Selection and tagging:
 - Signal specifications, net classes, differential nets, clock nets in most tools depend on naming conventions. A net database with naming conventions is convenient for automated process
- Manage rule set and parameters
 - Checking all rules results in hundreds of violations, lots of false or non-critical violations, difficulties in routing. Rules priorities should be used
 - Rule parameters should be customized based on nets' types
- Smart Rules
 - Automatically check violations to make sure that they apply considering other design factors:
 - E.g. critical nets routed too close to PCB edge but the PCB has via stitching. This should not be a violation.
 - E.g. critical nets routed close to a series of antipads that effectively create a slot. This should be a violation

7

Design Guidelines Using Simulations

- DRC tools requires engineer to define constraint values for rules
- Theoretical design rule recommendations might not be optimal for the specific type of board designs
- Rule of thumb suggestions are not sufficient in practical designs
- Simulations may have to be used to study the effects of the design rules in a specific design
 - Example of impact of design guideline parameters on EMC performance

Example of Design Guidelines Parameters using simulations

- Stitching vias around the board
 - Benefit of the stitching vias
 - Optimal distance between the stitching vias
- High speed signals near the apertures
 - Impact on emissions
 - Design recommendations to reduce the aperture effects

Stitching Vias Around the Board

Board edges should be stitched to reduce fields leakage from the edges.

Ideally board should be plated, but

- Might not be beneficial
- EMI from other sources could dominate
- Specially when mechanical holes are not shielded

Common-mode excitation



- Evaluate the potential EMC benefits while using stitching vias
- Propose optimal stitching via separation







Edge stitching vias

Effect of the Stitching Vias



Original design without stitching vias



Original design with stitching vias

- Stitching vias does not affect emissions above 5 GHz
- Emissions are dominated by the holes and/or exposed sources (traces, components,...)



Design Recommendations for Effective Stitching Vias



• Stitching Vias need to be placed around edges and apertures

12

Recommendations: Vias Stitching

- Emission level depends on
 - Placement proximity of the hole with the signal trace
 - Grounding via density and placement
- The edge stitching is effective when, via stitching around edges and holes are the same



High Speed Signal Near the Aperture

Differential pair near the aperture

Radiation mechanism:

- High speed signal couples to nearby apertures
- Apertures resonate like slot antennas
- Currents escape through apertures and radiate from the edges of a board

Objectives:

- Investigate impact of the aperture on emissions
- Propose design recommendations to reduce aperture effects



Effect of the Apertures and Holes









- Half-wavelength slot resonance at 3.3 GHz
- 4.8 GHz, 5.2 GHz, 6.1 GHz... are due to board dimensions

Design Solutions





Place stitching vias around the slot



Move the slot away from the Trace



Subdivide the slot with GND traces



Slot is subdivided:

- Current goes around the vias and does not spread to the board edges
- There is no slot, so $\lambda/2$ resonance at 3.3 GHz is gone

Recommendations: A Trace Near an Aperture

Highly recommended

• Subdivide the slot

Recommended

• Place stitching vias around an aperture

Optional, but preferable

• Move an aperture away from the high speed trace

Conclusions and Recommendations

- DRC tools can be very effective and save significant time in PCB review
 - Rule priorities and design parameters for the rules have been defined
 - Many PCB revisions need to be reviewed
 - Hundreds of nets, many layers
 - Database of nets and naming conventions need to be defined only one time

- Automation
 - The process can be automated to same extent
 - Rule customization ("Smart" rules, avoiding false violations, avoiding missing violations)
 - Integration with PCB layout tools (for violations checking and visualization)
 - Integration with simulation tools to define design parameters